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Inventor Information

Inventor One Given Name:: Jun-ichiro
Family Name:: FURIHATA
Name Suffix::
City of Residence:: Annaka-shi
State or Prov. of Residence:: Gunma
Country of Residence:: Japan
Inventor Two Given Name:: Kiyoshi
Family Name:: MITANI
Name Suffix::
City of Residence:: Annaka-shi
State or Prov. of Residence:: Gunma
Country of Residence:: Japan

Correspondence Information

Correspondence Customer Number:: 25944
Name Line One:: Oliff & Berridge PLC
Address Line One:: P.O. Box 19928
City:: Alexandria
State or Province:: VA
Postal or Zip Code:: 22320
Telephone:: (703) 836-6400
Fax:: (703) 836-2787
Electronic Mail:: commcenter@oliff.com

Application Information

Title Line One:: A METHOD OF PRODUCING A BONDED
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Continuity Information

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Prior Foreign Applications

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